

# 1A, 200V - 600V Super Fast Bridge Rectifier

#### **FEATURES**

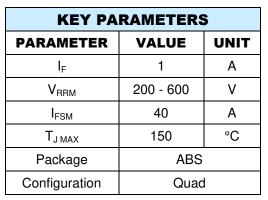
- AEC-Q101 qualified available
- Ideal for automated placement, for compact PCB design
- High surge current capability
- Super fast reverse recovery time for high frequency
- Negligible leakage current
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

| $\Lambda D$ | DI | ICA | TI |   | 2 M |
|-------------|----|-----|----|---|-----|
| AF          |    | LOM |    | u | 4-2 |

- Switching mode power supply (SMPS)
- Adapters
- Lighting application

#### **MECHANICAL DATA**

- Case: ABS
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: As marked
- Weight: 0.090g (approximately)



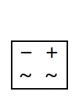


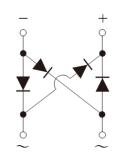






**ABS** 





| ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25°C unless otherwise noted)            |                  |              |        |                  |      |
|--|------------------|--------------|--------|------------------|------|
| PARAMETER  | SYMBOL           | EABS1D       | EABS1G | EABS1J           | UNIT |
| Marking code on the device   |                  | EABS1D       | EABS1G | EABS1J           |      |
| Repetitive peak reverse voltage  | $V_{RRM}$        | 200          | 400    | 600              | ٧    |
| Reverse voltage, total rms value   | $V_{R(RMS)}$     | 140          | 280    | 420              | V    |
| Forward current  | I <sub>F</sub>   |              | 1      |                  | Α    |
| Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load | I <sub>FSM</sub> | 40           |        | А                |      |
| Rating for fusing (t<8.3ms)  | l <sup>2</sup> t | 6.64         |        | A <sup>2</sup> s |      |
| Junction temperature   | TJ               | - 55 to +150 |        | °C               |      |
| Storage temperature  | T <sub>STG</sub> | - 55 to +150 |        | °C               |      |

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| THERMAL PERFORMANCE                    |                 |     |      |  |  |
|--|-----------------|-----|------|--|--|
| PARAMETER                              | SYMBOL          | TYP | UNIT |  |  |
| Junction-to-lead thermal resistance    | $R_{\Theta JL}$ | 25  | °C/W |  |  |
| Junction-to-ambient thermal resistance | $R_{\Theta JA}$ | 80  | °C/W |  |  |

| ELECTRICAL SPECIFICATIONS (T <sub>A</sub> = 25°C unless otherwise noted) |        |  |                 |     |      |      |
|--|--------|--|-----------------|-----|------|------|
| PARAMETER  |        | CONDITIONS                                   | SYMBOL          | TYP | MAX  | UNIT |
|  | EABS1D | I <sub>F</sub> = 1A, T <sub>J</sub> = 25°C   | V <sub>F</sub>  | -   | 0.95 | V    |
| Forward voltage per diode <sup>(1)</sup>                                 | EABS1G |  |                 | -   | 1.20 | V    |
|  | EABS1J |  |                 | -   | 1.70 | V    |
| Reverse current @ rated V <sub>R</sub> per diode <sup>(2)</sup>          |        | T <sub>J</sub> = 25°C                        |                 | -   | 1    | μΑ   |
|  |        | T <sub>J</sub> = 125°C                       | I <sub>R</sub>  | -   | 200  | μΑ   |
| Reverse recovery time  |        | $I_F = 0.5A$ , $I_R = 1.0A$ $I_{rr} = 0.25A$ | t <sub>rr</sub> | -   | 35   | ns   |

#### Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

| ORDERING INFORMATION            |         |                     |  |  |
|---------------------------------|---------|---------------------|--|--|
| ORDERING CODE <sup>(1)(2)</sup> | PACKAGE | PACKING             |  |  |
| EABS1x                          | ABS     | 5,000 / Tape & Reel |  |  |
| EABS1xH                         | ABS     | 5,000 / Tape & Reel |  |  |

## Notes:

- 1. "x" defines voltage from 200V(EABS1D) to 600V(EABS1J)
- 2. "H" means AEC-Q101 qualified



#### **CHARACTERISTICS CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

**Fig.1 Forward Current Derating Curve** 

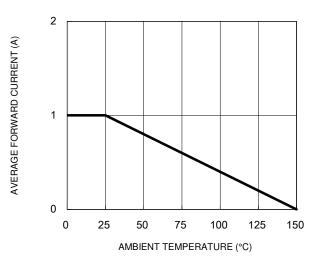
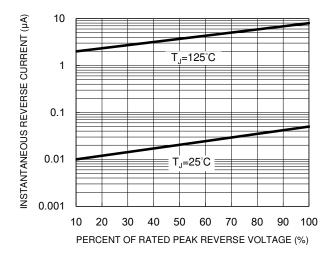


Fig.3 Typical Reverse Characteristics



**Fig.2 Typical Junction Capacitance** 

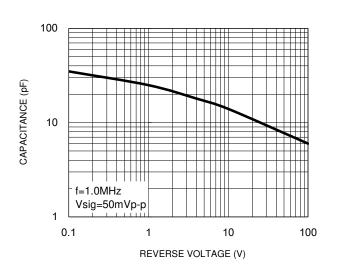


Fig.4 Typical Forward Characteristics

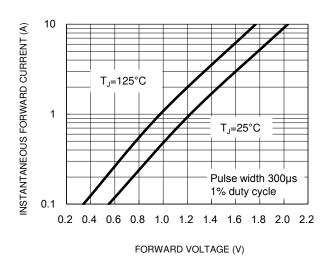
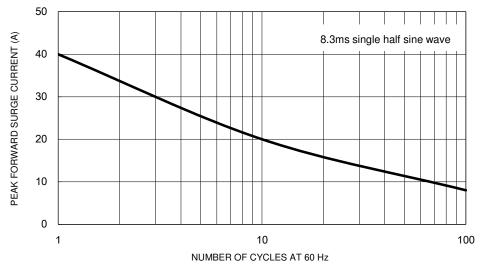
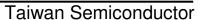


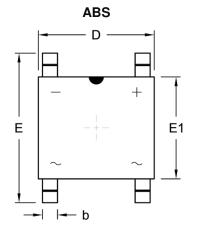
Fig.5 Maximum Non-Repetitive Forward Surge Current

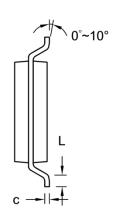


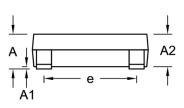




## **PACKAGE OUTLINE DIMENSIONS**

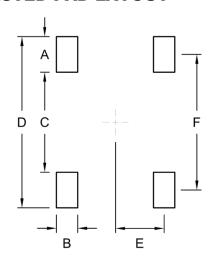






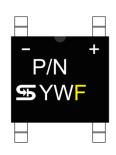
| DIM.   | Unit (mm) |      | Unit ( | (inch) |  |
|--------|-----------|------|--------|--------|--|
| Dilvi. | Min.      | Max. | Min.   | Max.   |  |
| Α      | 1.40      | 1.60 | 0.055  | 0.063  |  |
| A1     | 0.05      | 0.15 | 0.002  | 0.006  |  |
| A2     | 1.35      | 1.45 | 0.053  | 0.057  |  |
| b      | 0.60      | 0.70 | 0.024  | 0.028  |  |
| С      | 0.15      | 0.25 | 0.006  | 0.010  |  |
| D      | 4.90      | 5.10 | 0.193  | 0.201  |  |
| E      | 6.25      | 6.65 | 0.246  | 0.262  |  |
| E1     | 4.30      | 4.50 | 0.169  | 0.177  |  |
| е      | 3.90      | 4.10 | 0.154  | 0.161  |  |
| L      | 0.30      | 0.70 | 0.012  | 0.028  |  |

## **SUGGESTED PAD LAYOUT**



| Symbol | Unit (mm) | Unit (inch) |
|--------|-----------|-------------|
| Α      | 1.50      | 0.059       |
| В      | 0.90      | 0.035       |
| С      | 4.22      | 0.166       |
| D      | 7.22      | 0.284       |
| E      | 2.05      | 0.081       |
| F      | 5.72      | 0.225       |

## **MARKING DIAGRAM**



P/N = Marking Code

YW = Date Code

F = Factory Code



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